

February 2006

Boomer® Audio Power Amplifier Series **LM4982 Ground-Referenced, Ultra Low Noise, 80mW Stereo Headphone Amplifier with IntelliSense and I2C Volume Control**

General Description

The LM4982 is a ground referenced, variable gain audio power amplifier capable of delivering 80mW of continuous average power into a 16Ω single-ended load with less than 1% THD+N from a 3V power supply. The I²C volume control allows +18 to -76 dB gain settings.

The LM4982 utilizes advanced charge pump technology to generate the LM4982's negative supply voltage. This eliminates the need for output-coupling capacitors typically used with single-ended loads.

IntelliSense is a new circuit technology that allows the LM4982 to detect whether a mono or stereo headphone plug has been inserted into the output jack.

Boomer audio power amplifiers were designed specifically to provide high quality output power with a minimal amount of external components. The LM4982 does not require output coupling capacitors or bootstrap capacitors, and therefore is ideally suited for mobile phone and other low voltage applications where minimal power consumption is a primary requirement.

The LM4982 incorporates selectable low-power consumption shutdown and channel select modes.

The LM4982 contains advanced pop & click circuitry that eliminates noises which would otherwise occur during turn-on and turn-off transitions.

Key Specifications

- Improved PSRR at 217Hz 66dB
- Stereo Output Power at $V_{DD} = 3V$,
	- $R_L = 32Ω$, THD+N = 1% 51mW (typ)
- Shutdown current 0.1µA (typ)

Features

- Ground referenced outputs
- \blacksquare I²C Volume and mode controls
- Available in space-saving micro SMD package
- Ultra low current shutdown mode
- Advanced pop & click circuitry eliminates noises during turn-on and turn-off transitions
- \blacksquare 1.6 4.0V operation
- No output coupling capacitors, snubber networks, bootstrap capacitors or gain-setting resistors required
- Mono/Stereo headphone detect

Applications

- Notebook PCs
- Desktop PCs
- **Mobile Phones**
- n PDAs
- **Portable electronic devices**
- MP3 Players

Boomer® is a registered trademark of National Semiconductor Corporation.

Typical Application

20161466

FIGURE 1. Typical Audio Amplifier Application Circuit

Absolute Maximum Ratings [\(Note 2\)](#page-4-0)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Operating Ratings

Audio Amplifier Electrical Characteristics V_{DD} = 3V (Notes [1, 2\)](#page-4-0)

Control Interface Electrical Characteristics (Notes 1, 2)

The following specifications apply for 1.6V < V_{DD} < 4.0V, unless otherwise specified. Limits apply for T_A = 25°C.

Note 1: All voltages are measured with respect to the GND pin unless otherwise specified.

Note 2: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional but do not quarantee specific performance limits. Electrical Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX}, θ_{JA}, and the ambient temperature, Τ_A. The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower. For the LM4982, see power derating currents for more information.

Note 4: Human body model, 100pF discharged through a 1.5kΩ resistor.

Note 5: Machine Model, 220pF - 240pF discharged through all pins.

Note 6: Typicals are measured at +25˚C and represent the parametric norm.

Note 7: Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

Note 8: Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

LM4982

Typical Performance Characteristics THD+N vs Frequency V_{DD} = 1.8V, R_L = 16Ω, P_{O} = 7mW, Mono 10 10 $\overline{1}$ 5 5 \overline{a} $\overline{\mathbf{c}}$ $\overline{1}$ $\overline{1}$ 0.5 0.5 THD+N (%) 0.2 THD+N(%) 0.2 0.1 0.1 0.05 0.05 0.02 0.02 0.01 0.01 $.005$ 0.005 $.002$ 0.002 $\perp \perp \perp$ $.001$ 0.001 50 100 200 500 1k $2k$ $20\,$ 5k 10k 20k 20 FREQUENCY (Hz) **THD+N vs Frequency VDD = 1.8V, RL = 32**Ω**, P_O** = 7mW, Mono $10\,$ 10 5 $\overline{\mathbf{5}}$ \overline{a} $\overline{2}$ Ⅲ ₩ $\overline{1}$ $\overline{1}$ ĦŦ ▦ 0.5 ₩ ₩ 0.5 ╥ THD+N(%) 0.2 THD+N (%) 0.2 0.1 0.1 0.05 0.05 0.02 0.02 0.01 0.01 ₩ .005 $.005$ $.002$ $.002$ $.001$ $.001$ 20 50 100 200 500 1k 2k 5k 10k 20k 20 FREQUENCY (Hz) **THD+N vs Frequency** $V_{DD} = 3V$, $R_L = 16\Omega$, $P_{\text{O}} = 50$ mW, Mono 10 10 $\overline{5}$ 5 $\overline{2}$ $\overline{2}$ $\mathbf{1}$ $\mathbf{1}$ ₩ 0.5 0.5 THD+N(%) 0.2 THD+N $(%)$ 0.2 ╥╥ \perp \perp \perp \perp 0.1 0.1 ╪╪╪ 0.05 0.05 0.02 0.02 TШ 0.01 0.01 $.005$.005 $.002$ $.002$ $\perp \perp \perp \perp$ $.001$ $.001$ 20 50 100 200 500 1k 2k 5k 10k 20k 20 FREQUENCY (Hz) 20161482 20161483

 $\overline{20}$

100

120 140

 $\overline{250}$

200

80

150

 $\overline{25}$

 $\overline{3}0$

LM4982

Output Power vs Power Supply Voltage RL = 16Ω**, f = 1kHz, Stereo**

4

THD+N = 1%

 $\overline{\mathbf{A}}$

 3.5 4.0 4.5

POWER SUPPLY VOLTAGE (V)

5

5

LM4982

POWER SUPPLY VOLTAGE (V)

201614A6 201614A7

Typical Performance Characteristics (Continued) **PSRR vs Frequency** $V_{DD} = 1.8V$, Vripple = 200mVp-p $\mathbf 0$ POWER SUPPLY REJECTION RATIO (dB) POWER SUPPLY REJECTION RATIO (dB) -10 -20 -30 -40 -50 -60 -70 -80 -90 -100 50 100 200 500 1k 2k 5k 10k 20k 20 FREQUENCY (Hz) **PSRR vs Frequency** $V_{DD} = 3.6V$, Vripple = 200mVp-p $\mathbf 0$ POWER SUPPLY REJECTION RATIO (dB) -10 -20 CHANNEL SEPERATION (dB) -30 -40 -50 -60 -70 -80 -90 -100 20 50 100 200 500 1k 2k 5k 10k 20k FREQUENCY (Hz) 201614B0 201614B3 **Crosstalk V**_{DD} = 3V, RL = 32Ω, P_O= 50mW $\pmb{0}$ -10 ₩ -20 CHANNEL SEPERATION (dB) -30 -40 -50 -60 Ш $-70\,$ Ш -80 1 I I I -90 Ш -100 50 100 200 500 1k 2k 5k 10k 20k 20 FREQUENCY (Hz)

FREQUENCY (Hz)

PSRR vs Frequency V_{DD} = 3V, Vripple = 200mVp-p

 $\overline{0}$

 -10

201614B4

TABLE 1. Chip Address

*** Mono mode mixes (Left + Right) / 2, into Left output**

I 2 C VOLUME CONTROL

The LM4982 can be configured in 32 different gain steps by forcing I2C volume control bits to a desired gain according to the table below:

HP SENSE FUNCTION

Connecting headphones to the headphone jack disconnects the headphone jack contact pin from OUT_L and allows Rpu to pull the HP Sense pin up to V_{DD} . This enables the device. A microprocessor or a switch can replace the headphone jack contact pin.

INTELLISENSE

National's Intellisense technology allows the LM4982 to detect whether a mono or stereo headphone has been insterted in to the headphone jack. If a mono headphone is inserted into a device that is designed for a stereo headphone, one of the amplifiers will be shorted to ground. Without Intellisense, this may damage the device or, best case, the device will draw excessive current, shortening battery life.

Intellisense works by first waiting for one of the following events:

• When the device powers up, if a headphone is already inserted

• When a headphone is inserted, if the device is already powered up

• After the thermal shutdown circuitry is activated.

The occurrence of one of these events triggers the Intellisense circuitry to apply a small voltage on both left and right outputs and sense the resulting current through the load. If the load connected to the amplifier is greater than 9Ω, the amplifier driving it will be in full power mode. If the load is less than 3Ω, the LM4982 will assume a short to ground and shutdown the driving amplifier. Intellisense puts the LM4982 in mono mode when the right channel is shorted. For extra protection both amplifiers will be shutdown when the left channel is shorted to ground. The Intellisense feature can be enabled and disabled through an I2C command.

This Intellisense feature is designed for headphones with a nominal impedance of 16Ω or greater, using lower impedance loads may cause this feature to operate incorrectly.

LM4982

FIGURE 5.

MONO/STEREO OPERATION

When Intellisense is disabled the value of the CD1 bit of the mode control determines if the LM4982 is in mono or stereo mode. When the LM4982 is in mono mode the left and right input signals are mixed to the left channel amplifier and attenuated by -6dB. The right channel amplifier is put in shutdown to save power. The mixing function allows full reproduction of a stereo input signal in a mono headphone and optimum headroom is kept by attenuating by a factor of two.

I 2 C COMPATIBLE INTERFACE

The LM4982 uses a serial bus, which conforms to the 1^2C protocol, to control the chip's functions with two wires: clock (SCL) and data (SDA). The clock line is uni-directional. The data line is bi-directional (open-collector). The maximum clock frequency specified by the I²C standard is 400kHz. In this discussion, the master is the controlling microcontroller and the slave is the LM4982.

The bus format for the I²C interface is shown in Figure 2. The bus format diagram is broken up into six major sections:

The "start" signal is generated by lowering the data signal while the clock signal is high. The start signal will alert all devices attached to the 1^2C bus to check the incoming address against their own address.

The 8-bit chip address is sent next, most significant bit first. The data is latched in on the rising edge of the clock. Each address bit must be stable while the clock level is high.

After the last bit of the address bit is sent, the master releases the data line high (through a pull-up resistor). Then the master sends an acknowledge clock pulse. If the LM4982 has received the address correctly, then it holds the data line low during the clock pulse. If the data line is not held low during the acknowledge clock pulse, then the master should abort the rest of the data transfer to the LM4982.

The 8 bits of data are sent next, most significant bit first. Each data bit should be valid while the clock level is stable high.

After the data byte is sent, the master must check for another acknowledge to see if the LM4982 received the data.

If the master has more data bytes to send to the LM4982, then the master can repeat the previous two steps until all data bytes have been sent.

The "stop" signal ends the transfer. To signal "stop", the data signal goes high while the clock signal is high. The data line should be held high when not in use.

15 www.national.com

I²C INTERFACE POWER SUPPLY PIN (I²CV_{DD})

The LM4982's 1^2C interface is powered up through the 1^2 CV_{DD} pin. The LM4982's 1^2 C interface operates at a voltage level set by the I²CV_{DD} pin which can be set independent to that of the main power supply pin V_{DD} . This is ideal whenever logic levels for the I²C interface are dictated by a microcontroller or microprocessor that is operating at a lower supply voltage than the main battery of a portable system.

POWER SUPPLY BYPASSING

As with any power amplifier, proper supply bypassing is critical for low noise performance and high power supply rejection. Applications that employ a 5V regulator typically use a 10µF in parallel with a 0.1µF filter capacitors to stabilize the regulator's output, reduce noise on the supply line, and improve the supply's transient response. However, their presence does not eliminate the need for a local 1.0µF tantalum bypass capacitance connected between the LM4982's supply pins and ground. Keep the length of leads and traces that connect capacitors between the LM4982's power supply pins and ground as short as possible.

ELIMINATING THE OUTPUT COUPLING CAPACITOR

The LM4982 features a low noise inverting charge pump that generates an internal negative supply voltage. This allows the outputs of the LM4982 to be biased about GND instead of a nominal DC voltage, like traditional headphone amplifiers. Because there is no DC component, the large DC blocking capacitors (typically 220µF) are not necessary. The coupling capacitors are replaced by two, small ceramic charge pump capacitors, saving board space and cost.

Eliminating the output coupling capacitors also improves low frequency response. In traditional headphone amplifiers, the headphone impedance and the output capacitor form a high pass filter that not only blocks the DC component of the output, but also attenuates low frequencies, impacting the bass response. Because the LM4982 does not require the output coupling capacitors, the low frequency response of the device is not degraded by external components.

In addition to eliminating the output coupling capacitors, the ground referenced output nearly doubles the available dynamic range of the LM4982 when compared to a traditional headphone amplifier operating from the same supply voltage.

OUTPUT TRANSIENT ('CLICK AND POPS') ELIMINATED

The LM4982 contains advanced circuitry that virtually eliminates output transients ('clicks and pops'). This circuitry prevents all traces of transients when the supply voltage is first applied or when the part resumes operation after coming out of shutdown mode.

POWER DISSIPATION

Power dissipation is a major concern when using any power amplifier and must be thoroughly understood to ensure a successful design. Equation 1 states the maximum power dissipation point for a single-ended amplifier operating at a given supply voltage and driving a specified output load.

$$
P_{\text{DMAX}} = (2V_{\text{DD}})^2 / (2\pi^2 R_L)
$$
 (1)

Since the LM4982 has two operational amplifiers in one package, the maximum internal power dissipation point is twice that of the number which results from Equation 1. Even with large internal power dissipation, the LM4982 does not require heat sinking over a large range of ambient temperatures. The maximum power dissipation point obtained must not be greater than the power dissipation that results from Equation 2:

$$
P_{\text{DMAX}} = (T_{\text{JMAX}} - T_A) / (\theta_{\text{JA}})
$$
 (2)

For the micro SMD package, $\theta_{JA} = 105^{\circ}$ C/W. $T_{JMAX} = 150^{\circ}$ C for the LM4982. Depending on the ambient temperature, T_A , of the system surroundings, Equation 2 can be used to find the maximum internal power dissipation supported by the IC packaging. If the result of Equation 1 is greater than that of Equation 2, then either the supply voltage must be decreased, the load impedance increased or T_A reduced. Power dissipation is a function of output power and thus, if typical operation is not around the maximum power dissipation point, the ambient temperature may be increased accordingly.

SELECTING PROPER EXTERNAL COMPONENTS

Optimizing the LM4982's performance requires properly selecting external components. Though the LM4982 operates well when using external components with wide tolerances, best performance is achieved by optimizing component values.

Charge Pump Capacitor Selection

Use low ESR (equivalent series resistance) (<100mΩ) ceramic capacitors with an X7R dielectric for best performance. Low ESR capacitors keep the charge pump output impedance to a minimum, extending the headroom on the negative supply. Higher ESR capacitors result in reduced output power from the audio amplifiers.

Charge pump load regulation and output impedance are affected by the value of the flying capacitor (C1). A larger valued C1 (up to 3.3uF) improves load regulation and minimizes charge pump output resistance. Beyond 3.3uF, the switch-on resistance dominates the output impedance for capacitor values above 2.2uF.

The output ripple is affected by the value and ESR of the output capacitor (C2). Larger capacitors reduce output ripple on the negative power supply. Lower ESR capacitors minimize the output ripple and reduce the output impedance of the charge pump.

The LM4982 charge pump design is optimized for 2.2uF, low ESR, ceramic, flying, and output capacitors.

Input Capacitor Value Selection

Amplifying the lowest audio frequencies requires high value input coupling capacitors (C_i in Figure 1). A high value capacitor can be expensive and may compromise space efficiency in portable designs. In many cases, however, the speakers used in portable systems, whether internal or external, have little ability to reproduce signals below 150Hz. Applications using speakers with this limited frequency response reap little improvement by using high value input and output capacitors.

Besides affecting system cost and size, C_i has an effect on the LM4982's click and pop performance. The magnitude of the pop is directly proportional to the input capacitor's size.

Thus, pops can be minimized by selecting an input capacitor value that is no higher than necessary to meet the desired −3dB frequency.

As shown in Figure 1, the internal input resistor, R_i and the input capacitor, C_i, produce a -3dB high pass filter cutoff frequency that is found using Equation (3). Conventional headphone amplifiers require output capacitors; Equation (3) can be used, along with the value of R_L , to determine towards the value of output capacitor needed to produce a –3dB high pass filter cutoff frequency.

 $f_{i-3dB} = 1 / 2\pi R_i C_i$

LM4982

Also, careful consideration must be taken in selecting a certain type of capacitor to be used in the system. Different types of capacitors (tantalum, electrolytic, ceramic) have unique performance characteristics and may affect overall system performance. (See the section entitled Charge Pump Capacitor Selection.)

Demo Board Artwork

Top Layer

Mid Layer 1

Revision History

